Product Specification

7.0" TFT LCD Module

Resolution:	800 X480
Interface:	RGB 50PIN
Luminance:	420cd/m ²

< >> Preliminary Specification

< >> Finally Specification

CUSTOMER'S APPROVAL					
CUSTOMER:					
SIG	NATURE:	DATE:			

APPROVED	PM	PD	PREPARED
ВҮ	REVIEWED	REVIEWED	BY

Revision History

Revision	Date	Originator	Detail	Remarks
1.0	2015.09.20			

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1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver ICs and a backlight unit.

2. Module Parameter

Features	Details	Unit
Display Size(Diagonal)	7.0"	
LCD type	TN TFT	
Display Mode	Transmissive /Normal white	
Resolution	800 RGB x 480	Pixels
View Direction	12 O'clock	Best Image
Gray Scale Inversion Direction	6 O'clock	
Module Outline	164.9(H) x100(V) x 5.7(T) (Note1)	mm
Active Area	154.08(H) x85.92(V)	mm
Pixel Size	192.6(H) x179(V)	um
Pixel Arrangement	R.G.B Stripe	
Polarizer Surface Treatment	Anti-glare	
Display Colors	16.7M	
Interface	24 Bit RGB	
With or Without Touch Panel	Without	
Operating Temperature	-20~70	°C
Storage Temperature	-30~80	°C
Weight	150	g

Note 1: Exclusive hooks, posts , FFC/FPC tail etc.

3. Absolute Maximum Ratings

Vss=0V, Ta=25°C

Item	Symbol	Min.	Max.	Unit
Supply Voltage	VCC	-0.3	5.0	V
Storage temperature	T _{STG}	-30	80	°C
Operating temperature	Тор	-20	70	°C

Note 1: If Ta below 50°C, the maximal humidity is 90%RH, if Ta over 50°C, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10 $^{\circ}$ C, and the back ground will become darker at high temperature operating.

4. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit
Digital Power Supply Voltage	DVDD	3.0	3.3	3.6	V
Analog Power Supply Voltage	AVDD	10.2	10.4	10.6	V
TFT Device on voltage	V_{GH}	15.3	16.0	16.7	V
TFT Device off voltage	V_{GL}	-7.7	-7.0	-6.3	V
Common Electrode Driving Voltage	VCOM	2.6	3.6	4.6	V
Low Level Input Voltage	VIL	0	-	0.3*DVDD	V
High Level Input Voltage	VIH	0.7*DVDD	-	DVDD	V

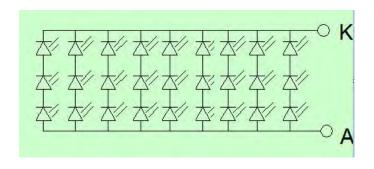
5. Backlight Characteristic

5.1. Backlight Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	VF	Ta=25 °C, I _F =20mA/LED	8.4	9.3	10.2	V
Forward Current	lF	Ta=25 °C, V _F =3.1V/LED	-	180	-	mA
Power dissipation	Po		-	1.674	-	W
Uniformity	Avg		70	75	-	%
LED working life(25°C)	-		-	30000	-	Hrs
Drive method	Constant current					
LED Configuration	27	White LEDs (3 LEDs in one	string and	l 9groups	in parallel)

Note1: LED life time defined as follows: The final brightness is at 50% of original brightness. The environmental conducted under ambient air flow, at $Ta=25\pm2$ °C,60%RH ±5 %, $I_F=20$ mA

5.2. Backlighting circuit



6. Optical Characteristics

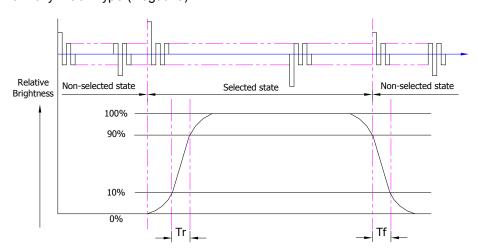
6.1. Optical Characteristics

Ta=25°C, DVDD=3.3V

	Item		Symbol	Condition	S	pecificati	on	Unit
			Syllibol	Condition	Min.	Тур.	Max.	Ullit
	Luminance on							
<u> </u>	$TFT(I_f \texttt{=20mA/LED})$		Lv	Normally	400	420	-	cd/m²
Backlight On (Transmissive Mode)	Contrast ratio	(See 6.3)	CR	viewing angle	-	500	-	
B ■	Response	time	Tr	θx =φY =0°	-	10	20	mo
Sive	(See 6.	.2)	TF		-	15	30	ms
nis		Red	XR		0.524	0.574	0.624	
nsı	'	Reu	YR		0.290	0.340	0.390	
 Tra	Chanamatiaita	Green	XG		0.272	0.322	0.372	
) u	Chromaticity Transmissive	Green	YG		0.556	0.606	0.656	
ht C		Blue	Хв		0.091	0.141	0.191	
ligl	(See 6.5)	blue	YB		0.040	0.090	0.140	
ack		White	Xw		0.244	0.294	0.344	
В		vvriite	Yw		0.286	0.336	0.386	
	Viewing	Horizont	θx+		60	70	-	
		al	Өх-	Center CR≥10	60	70	-	Deg.
	Angle	Vertical	фҮ+	Center CR210	40	50	-	Deg.
	(See 6.4)	vertical	φY-		60	70	-	

6.2. Definition of Response Time

6.2.1. Normally Black Type (Negative)

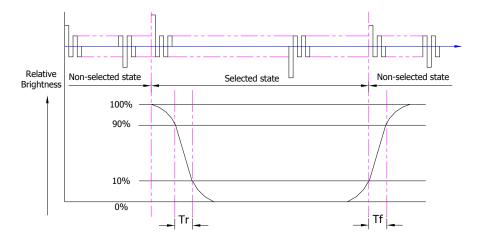


Tr is the time it takes to change form non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note: Measuring machine: LCD-5100

6.2.2. Normally White Type (Positive)



Tr is the time it takes to change form non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note: Measuring machine: LCD-5100 or EQUI

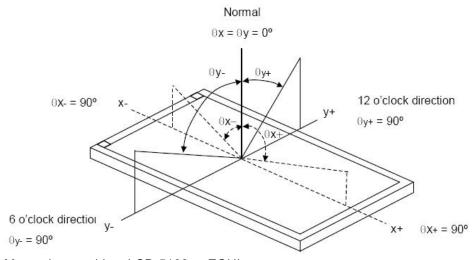
6.3. Definition of Contrast Ratio

Contrast is measured perpendicular to display surface in reflective and transmissive mode. The measurement condition is:

Measuring Equipment	Eldim or Equivalent
Measuring Point Diameter	3mm//1mm
Measuring Point Location	Active Area centre point
Toot nottorn	A: All Pixels white
Test pattern	B: All Pixel black
Contrast setting	Maximum

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

6.4. Definition of Viewing Angles



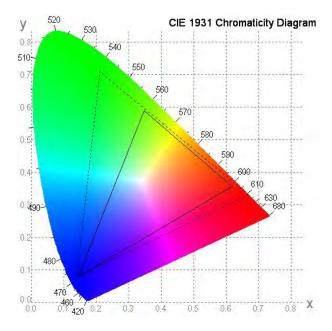
Measuring machine: LCD-5100 or EQUI

6.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram

NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)

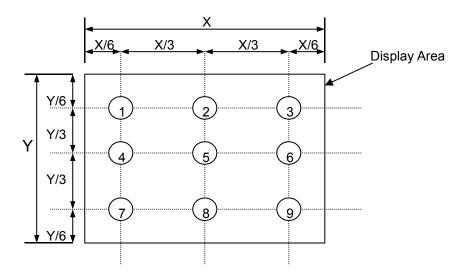


6.6. Definition of Surface Luminance, Uniformity and Transmittance

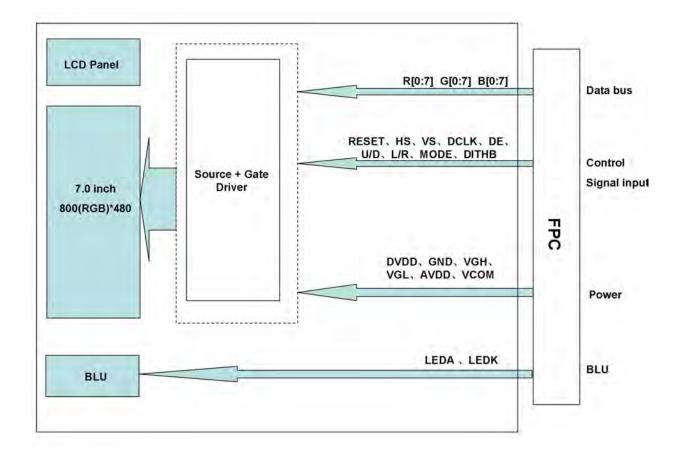
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

- 6.6.1. Surface Luminance: L_V = average (L_{P1} : L_{P9})
- 6.6.2. Uniformity = Minimal $(L_{P1}:L_{P9})$ / Maximal $(L_{P1}:L_{P9})$ * 100%
- 6.6.3. Transmittance = L_V on LCD / L_V on Backlight * 100%

Note: Measuring machine: BM-7



7. Block Diagram and Power Supply



No.	Symbol	Function	Remark
1	LEDA	Led anode	
2	LEDA	Led anode	
3	LEDK	Led cathode	
4	LEDK	Led cathode	
5	GND	Ground	
6	VCOM	Common voltage input	
7	DVDD	Digital power supply	
8	MODE	DE/SYNC mode select. H:DE mode, L:SYNC mode	
9	DE	Data enable signal, active high to enable data	
10	VS	Vertical sync input, negative polarity	
11	HS	Horizontal sync input, negative polarity	
12	B7	Blue data (MSB)	
13	B6	Blue data	
14	B5	Blue data	
15	B4	Blue data	
16	B3	Blue data	
17	B2	Blue data	
18	B1	Blue data	
19	В0	Blue data (LSB)	
20	G7	Green data (MSB)	
21	G6	Green data	
22	G5	Green data.	
23	G4	Green data	
24	G3	Green data	
25	G2	Green data	
26	G1	Green data.	
27	G0	Green data (LSB)	
28	R7	Red data (MSB)	
29	R6	Red data	
30	R5	Red data	
31	R4	Red data	
32	R3	Red data	
33	R2	Red data	
34	R1	Red data	
35	R0	Red data (LSB)	
36	GND	Ground	
37	DCLK	Clock for input data	
38	GND	Ground	
39	L/R	Source left or right sequence control	
40	U/D	Gate up or down scan control	
41	VGH	Positive power of TFT	
42	VGL	Negative power of TFT	
43	AVDD	Analog power supply	
	1	1	1

44	RESET	Global reset pin	
45	NC	No connection	
46	VCOM	Common voltage input	
47	DITHB	Dithering setting. H: 6bit resolution, L: 8bit resolution	
48	GND	Ground	
49	NC	No connection	
50	NC	No connection	

8. Interface Pins Definition

Note 1:DE/SYNC mode select. Normally pull high.

When select DE mode, MODE="1", VS and HS must pull high.

When select SYNC mode, MODE="0", DE must be grounded.

Note 2:When input 18 bits RGB data, the two low bits of R,G and B data must be grounded.

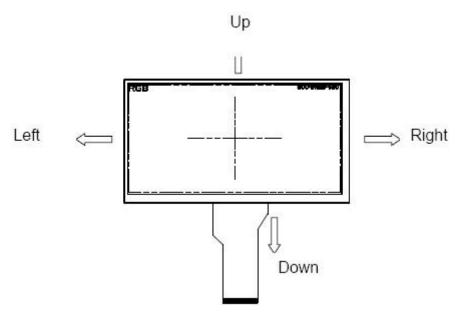
Note 3:Data shall be latched at the falling edge of DCLK.

Note 4:Selection of scanning mode

Setting of so	an control input	Scanning direction			
U/D	L/R	Scarring direction			
GND	DVDD	Up to down,left to right			
DVDD	GND	Down to up,right to left			
GND	GND	Up to down, right to left			
DVDD	DVDD	Down to up,left to right			

Note 5:Definition of scanning direction.

Refer to the figure as below:



Note 6:Global reset pin.Active low to enter reset state. Suggest to connect with an RC reset circuit for stability. Normally pull high.

Note7 :Dithering function enable control,normally pull high.

When DITHB="1", Disable internal dithering function,

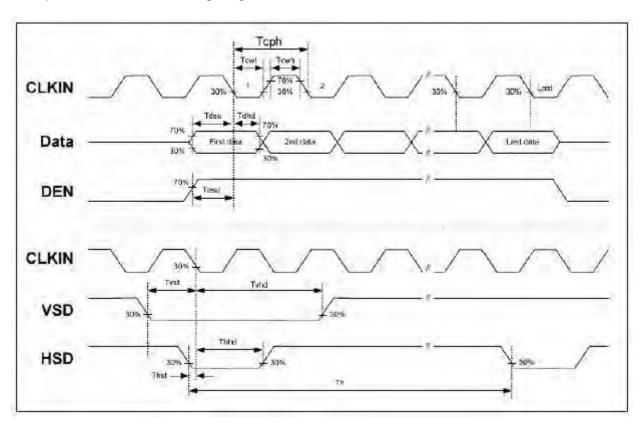
When DITHB="0", Enable internal dithering function.`

9. Timing Characteristics

9.1. AC Electrical Characteristics

Item	Cumbal		Values		Unit	Remark
item	Symbol	Min. Typ		Max.	Unit	Remark
HS setup time	Thst	8	(E s)	-	ns	60
HS hold time	Thhd	8	35	1573	ns	
VS setup time	Tvst	8	727	123	ns	
VS hold time	Tvhd	8	22)	828	ns	
Data setup time	Tdsu	8	-	-	ns	
Data hole time	Tdhd	8	551	878	ns	8
DE setup time	Tesu	8	5/35	1881	ns	
DE hole time	Tehd	8	32	323	ns	
DV _{DD} Power On Slew rate	Tpor	-	5 - 1	20	ms	From 0 to 90% DV _{DD}
RESET pulse width	TRst	1	32	12	ms	
DCLK cycle time	Tcoh	20	-		ns	
DCLK pulse duty	Tcwh	40	50	60	%	6

9.2. Input Clock and Data Timing Diagram

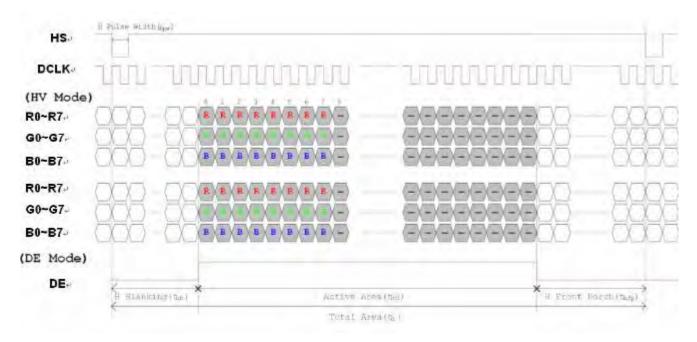


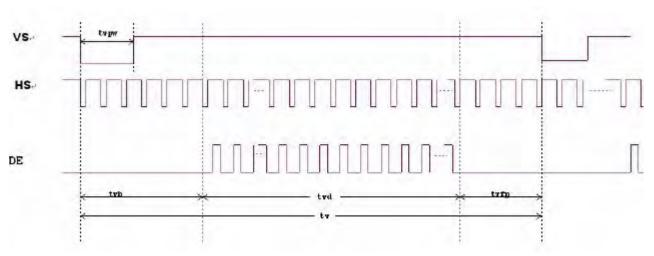
9.3. Timing

Item	Cumbal	Values			Unit	Remark
item	Symbol	Min.	Тур.	Max.	Onit	Kelliaik
Horizontal Display Area	thd	-	800	(40)	DCLK	
DCLK Frequency	fclk	26.4	33.3	46.8	MHz	
One Horizontal Line	th	862	1056	1200	DCLK	
HS pulse width	thpw	1	- 12	40	DCLK	
HS Blanking	thb	46	46	46	DCLK	
HS Front Porch	thfp	16	210	354	DCLK	

14	Values					
Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Vertical Display Area	tvd	92	480	-	TH	
VS period time	tv	510	525	650	TH	
VS pulse width	tvpw	1	200	20	TH	
VS Blanking	tvb	23	23	23	TH	
VS Front Porch	tvfp	7	22	147	TH	

9.4. Data Input Format

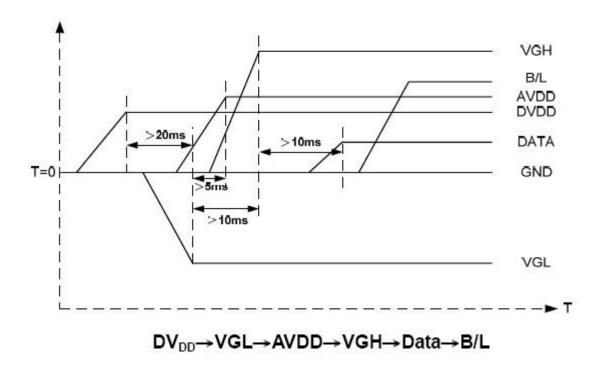




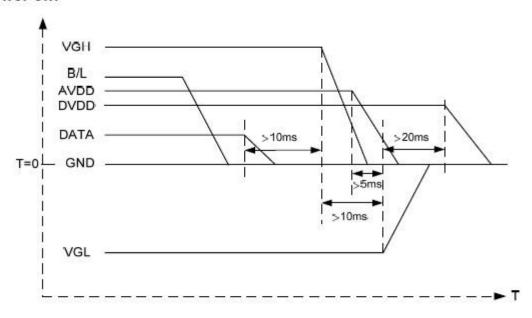
Vertical input timing diagram

9.5. Power Sequence

a. Power on:



b. Power off:



 $B/L \rightarrow Data \rightarrow VGH \rightarrow AVDD \rightarrow VGL \rightarrow DV_{DD}$

Note: Data include R0~R7, B0~B7, GO~G7, U/D, L/R, DCLK, HS,VS,DE.

10. Quality Assurance

10.1 Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

10.2 Standard for Quality Test

10.2.1 Sampling Plan:

GB2828.1-2012.

Single sampling, normal inspection.

10.2.2 Sampling Criteria:

Visual inspection: AQL 1.5% Electrical functional: AQL 0.65%.

10.2.3 Reliability Test:

Detailed requirement refer to Reliability Test Specification.

10.3 Nonconforming Analysis & Disposition

- 10.3.1 Nonconforming analysis:
 - 10.3.1.1 Customer should provide overall information of non-conforming sample for their complaints.
 - 10.3.1.2 After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.
 - 10.3.1.3 If can not finish the analysis on time, customer will be notified with the progress status.
- 10.3.2 Disposition of nonconforming:
 - 10.3.2.1 Non-conforming product over PPM level will be replaced.

10.3.2.2 The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

10.4 Agreement Items

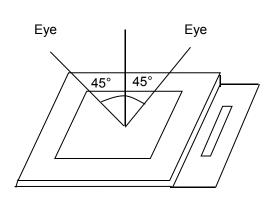
Shall negotiate with customer if the following situation occurs:

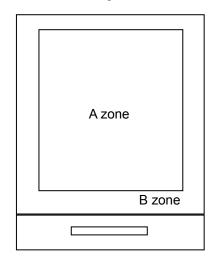
- 10.4.1 There is any discrepancy in standard of quality assurance.
- 10.4.2 Additional requirement to be added in product specification.
- 10.4.3 Any other special problem.

10.5 Standard of the Product Visual Inspection

10.5.1 Appearance inspection:

- 10.5.1.1 The inspection must be under illumination about 1000 1500 lx, and the distance of view must be at 30cm ± 2cm.
- 10.5.1.2 The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.
- 10.5.1.3 Definition of area: A Zone: Active Area, B Zone: Viewing Area,



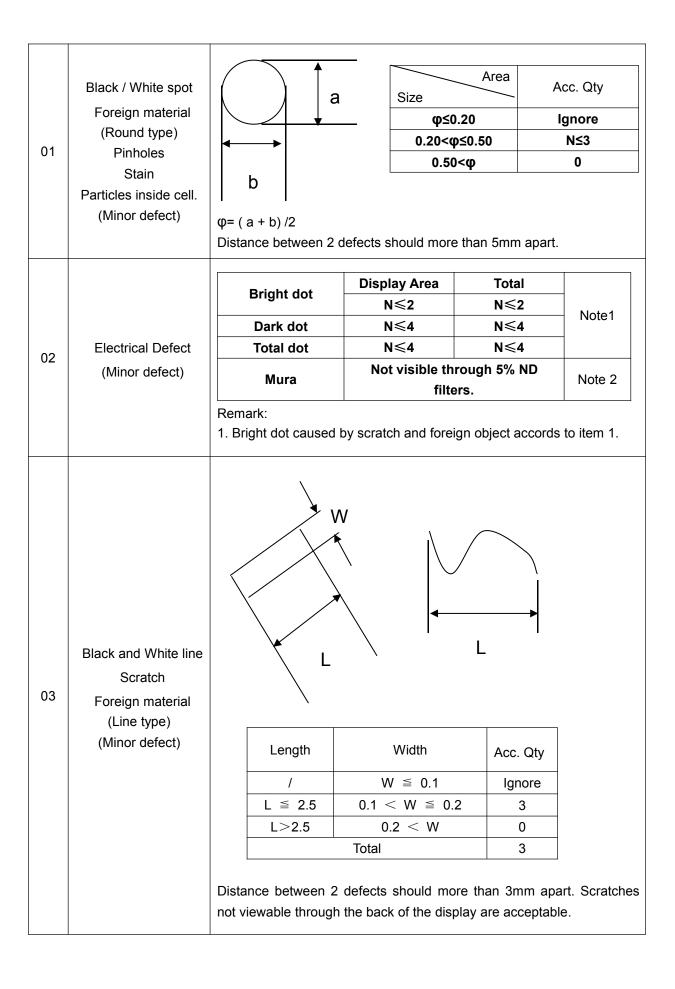


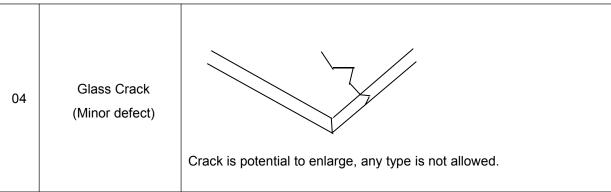
10.5.2 Basic principle:

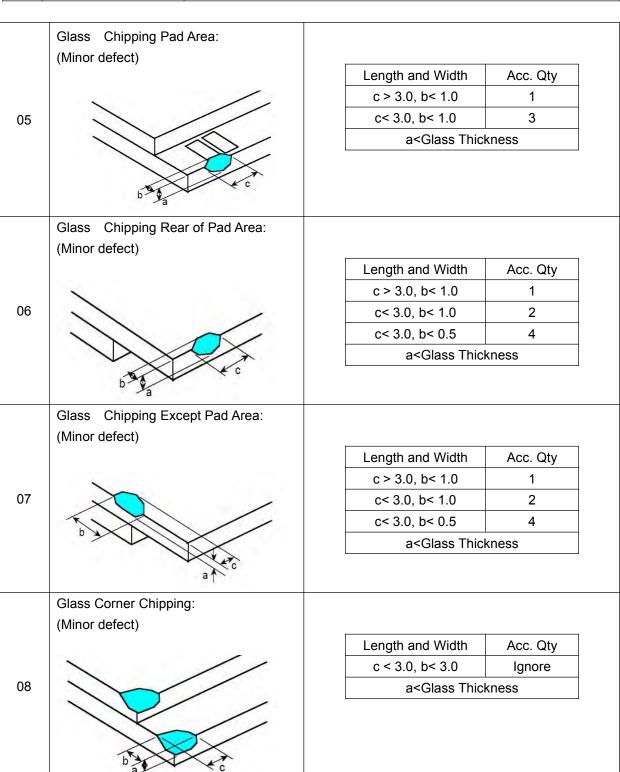
- 10.5.2.1 A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.
- 10.5.2.2 New item must be added on time when it is necessary.

10.6 Inspection Specification

No.	Item	Criteria (Unit: mm)
-----	------	---------------------







09	Glass Burr: (Minor defect)		Leng F < 1 Glass burr don't dimension.	.0	Acc. Qty Ignore
10	FPC Defect: (Minor defect)		10.1 Dent, pinhole (w: circuitry width.) 10.2 Open circuit is 10.3 No oxidation, o	unacceptable	
11	Bubble on Polarizer (Minor defect)		Diameter φ≤0.30 0.30 <φ≤0.50 0.50 < φ	Acc. Qty Ignore N≤2 N=0	
12	Dent on Polarizer (Minor defect)		Diameter φ≤0.25 0.25 <φ≤0.50 0.50 < φ	Acc. Qty Ignore N≤4 None	
13	Bezel	13.1 No rust, distor 13.2 No visible fing	tion on the Bezel. erprints, stains or othe	er contaminati	on.

		D: Diameter W: width L: length				
		14.1 Spot: D<0.25 is acceptable				
		0.25≤D≤0.4				
		2dots are acceptable and the distance between defects should more than				
		10 mm.				
14	Touch Panel	D>0.4 is unacceptable				
		14.2 Dent: D>0.40 is unacceptable				
		14.3 Scratch: W≤0.03, L≤10 is acceptable,				
		0.03 <w≤0.10, acceptable<="" is="" l≤10="" td=""></w≤0.10,>				
	Distance between 2 defects should more than 10 mm. W>0.10 is unacceptable.	Distance between 2 defects should more than 10 mm.				
		W>0.10 is unacceptable.				
		15.1 No distortion or contamination on PCB terminals.				
		15.2 All components on PCB must same as documented on the				
15	PCB	BOM/component layout.				
	15.3 Follow IPC-A-600F.					
		15.3 FOIIOW IPC-A-600F.				
16	Soldering	Follow IPC-A-610C standard				
		The below defects must be rejected.				
		17.1 Missing vertical / horizontal segment,				
		17.2 Abnormal Display.				
	Electrical Defect	17.3 No function or no display.				
17	(Major defect)	17.4 Current exceeds product specifications.				
	(iviajoi delect)	17.5 LCD viewing angle defect.				
		17.6 No Backlight.				
		17.7 Dark Backlight.				
		17.8 Touch Panel no function.				

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

10.7 Classification of Defects

- 10.7.1 Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.
- 10.7.2 Two minor defects are equal to one major in lot sampling inspection.

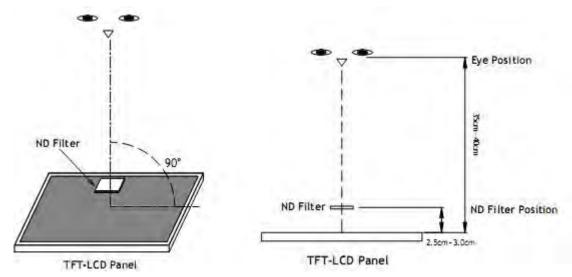
10.8 Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

10.9 Packing

- 10.9.1 There should be no damage of the outside carton box, each packaging box should have one identical label.
- 10.9.2 Modules inside package box should have compliant mark.
- 10.9.3 All direct package materials shall offer ESD protection

Note1:Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixelarea.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is $350 \text{mm} \pm 50 \text{mm}$.

Dark dot:Cyan,Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is $350 \text{mm} \pm 50 \text{mm}$.

Note2: Mura on display which appears darker / brighter against background brightness on parts of display area.

11. Reliability Specification

No	ltem	Condition	Quantity	Criteria
1	High Temperature Operating	70 ℃, 96Hrs	2	GB/T2423.2 -2008
2	Low Temperature Operating	-20℃, 96Hrs	2	GB/T2423.1 -2008
3	High Humidity	50℃, 90%RH, 96Hrs	2	GB/T2423.3 -2006
4	High Temperature Storage	80℃, 96Hrs	2	GB/T2423.2 -2008
5	Low Temperature Storage	-30℃, 96Hrs	2	GB/T2423.1 -2008
6	Thermal Cycling Test	-30°C, 60min~80°C, 60min, 20 cycles.	2	GB/T2423.22 -2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	2	GB/T5170.14 -2009
8	Electrical Static Discharge	Air: \pm 8KV 150pF/330 Ω 5 times	2	GB/T17626.2
	Licellical Static Discharge	Contact: ±4KV 150pF/330 Ω 5 times		-2006
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	2	GB/T2423.8 -1995

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value

12. Precautions and Warranty

12.1.Safety

- 12.1.1 The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.
- 12.1.2 Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

12.2. Handling

- 12.2.1 Reverse and use within ratings in order to keep performance and prevent damage.
- 12.2.2 Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

12.3.Storage

- 12.3.1. Do not store the LCD module beyond the specified temperature ranges.
- 12.3.2. Strong light exposure causes degradation of polarizer and color filter

12.4. Metal Pin (Apply to Products with Metal Pins)

- 12.4.1 Pins of LCD and Backlight
 - 12.4.1.1 Solder tip can touch and press on the tip of Pin LEAD during the soldering
 - 12.4.1.2 Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

Maximum Solder Temperature: 370 ℃

Maximum Solder Time: 3s at the maximum temperature

Recommended Soldering Temp: 350±20 ℃

Typical Soldering Time: ≤3s

12.4.1.3 Solder Wetting

Solder Pin Lead

Solder Pin Lead

Recommended

Not Recommended

12.4.2 Pins of EL

- 12.4.1.1 Solder tip can touch and press on the tip of EL leads during soldering.
- 12.4.1.2 No Solder Paste on the soldering pad on the motherboard is recommended.
- 12.4.1.3 Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270~290 ℃

Typical Soldering Time: ≤2s

Minimum solder distance from EL lamp (body):2.0mm

- 12.4.1.4 No horizontal press on the EL leads during soldering.
- 12.4.1.5 180° bend EL leads three times is not allowed.

12.4.1.6 Solder Wetting



Recommended

Not Recommended

12.4.1.7 The type of the solder iron:





Recommended

Not Recommended

12.4.1.8 Solder Pad



12.5. Operation

- 12.5.1. Do not drive LCD with DC voltage
- 12.5.2. Response time will increase below lower temperature
- 12.5.3. Display may change color with different temperature
- 12.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".
- 12.5.5. Do not connect or disconnect the LCM to or from the system when power is on.
- 12.5.6. Never use the LCM under abnormal condition of high temperature and high humidity.
- 12.5.7. Module has high frequency circuits. Sufficient suppression to the electromagnetic interface shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
- 12.5.8. Do not display the fixed pattern for long time (we suggest the time not longer than one hour) because it may develop image sticking due to the TFT structure.

12.6. Static Electricity

- 12.6.1. CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 12.6.2. The normal static prevention measures should be observed for work clothes and benches.
- 12.6.3. The module should be kept into anti-static bags or other containers resistant to static for storage.

12.7.Limited Warranty

- 12.7.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 12.7.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used
- 12.7.3. After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

